

FIG. 1 is a block diagram of a system 10. The system 10 includes a display 20, a row driver 30, a column driver 40, a system PC board controller 70, and a memory 50. The display 20 is connected to the row driver 30 and the column driver 40. The row driver 30 is connected to the system PC board controller 70. The column driver 40 is connected to the system PC board controller 70. The memory 50 is connected to the system PC board controller 70.

FIG. 1

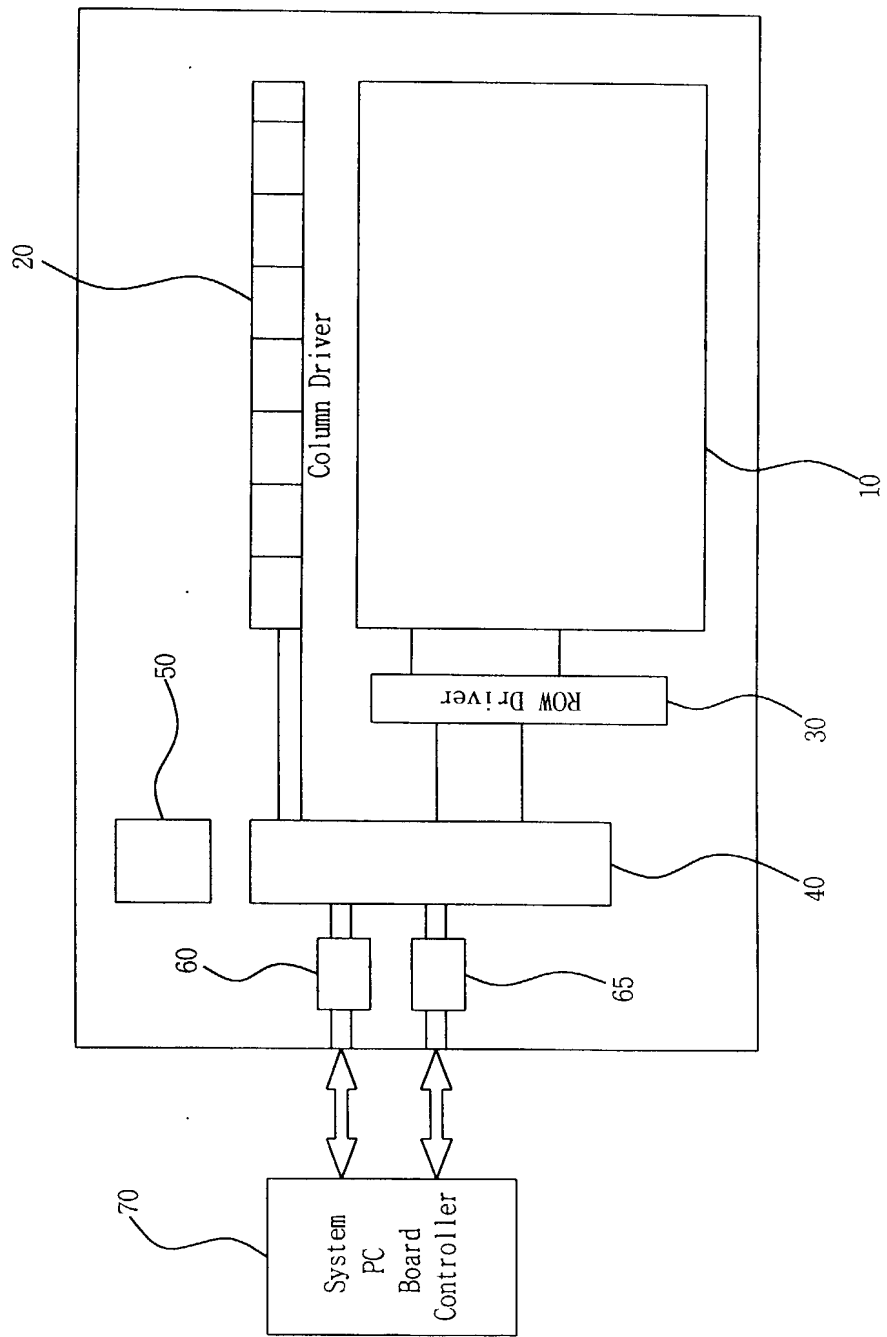


FIG. 2

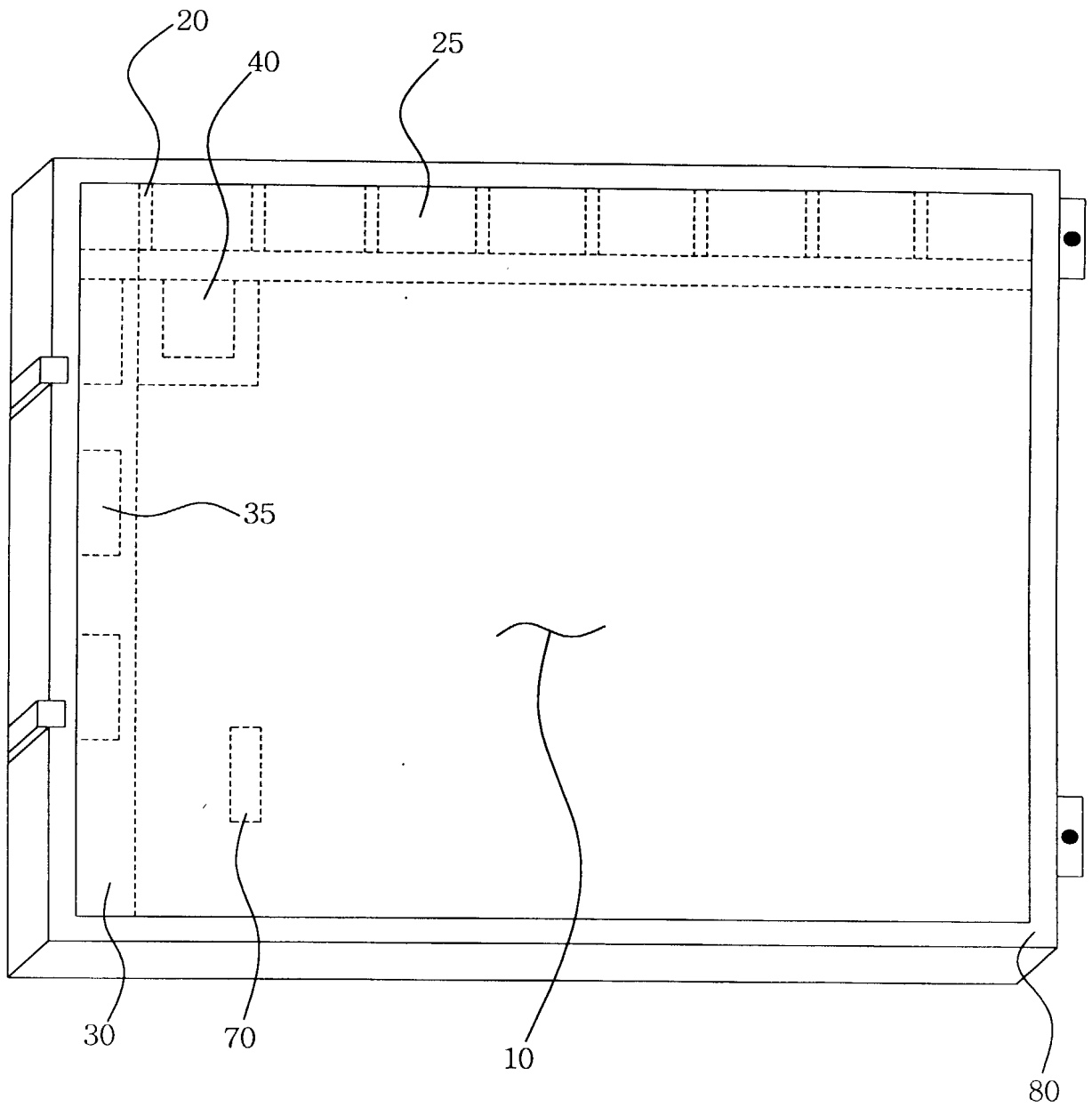


FIG. 3

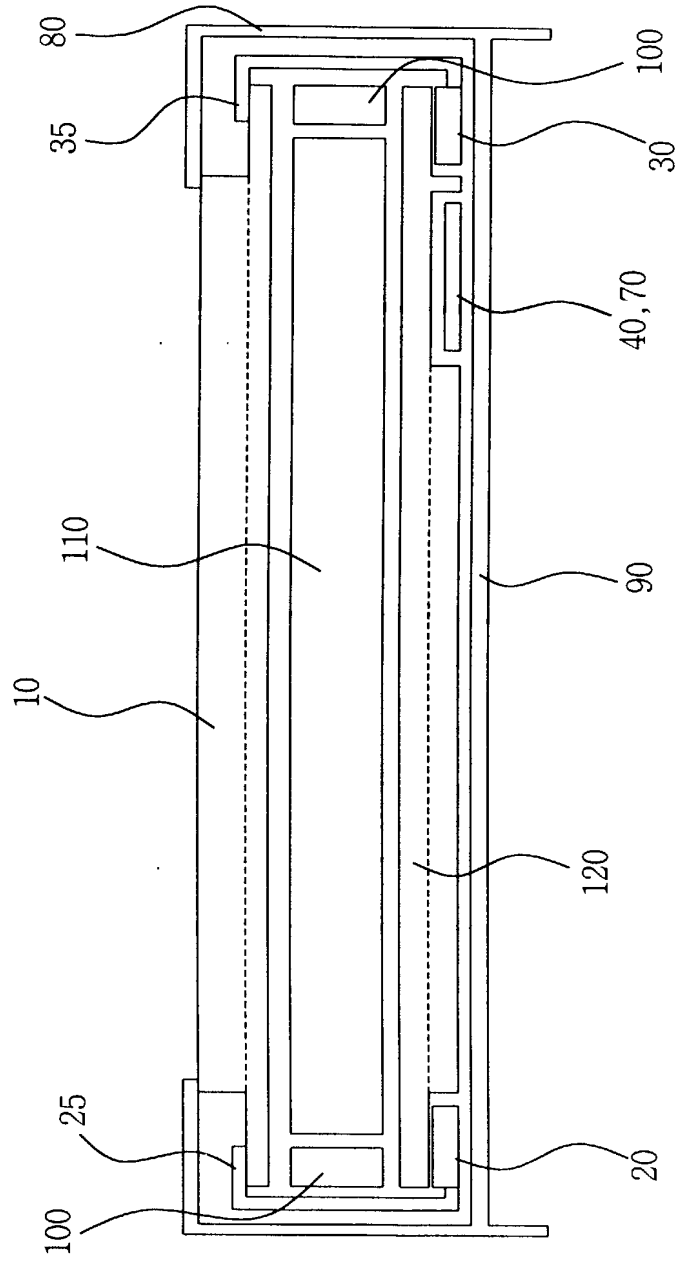
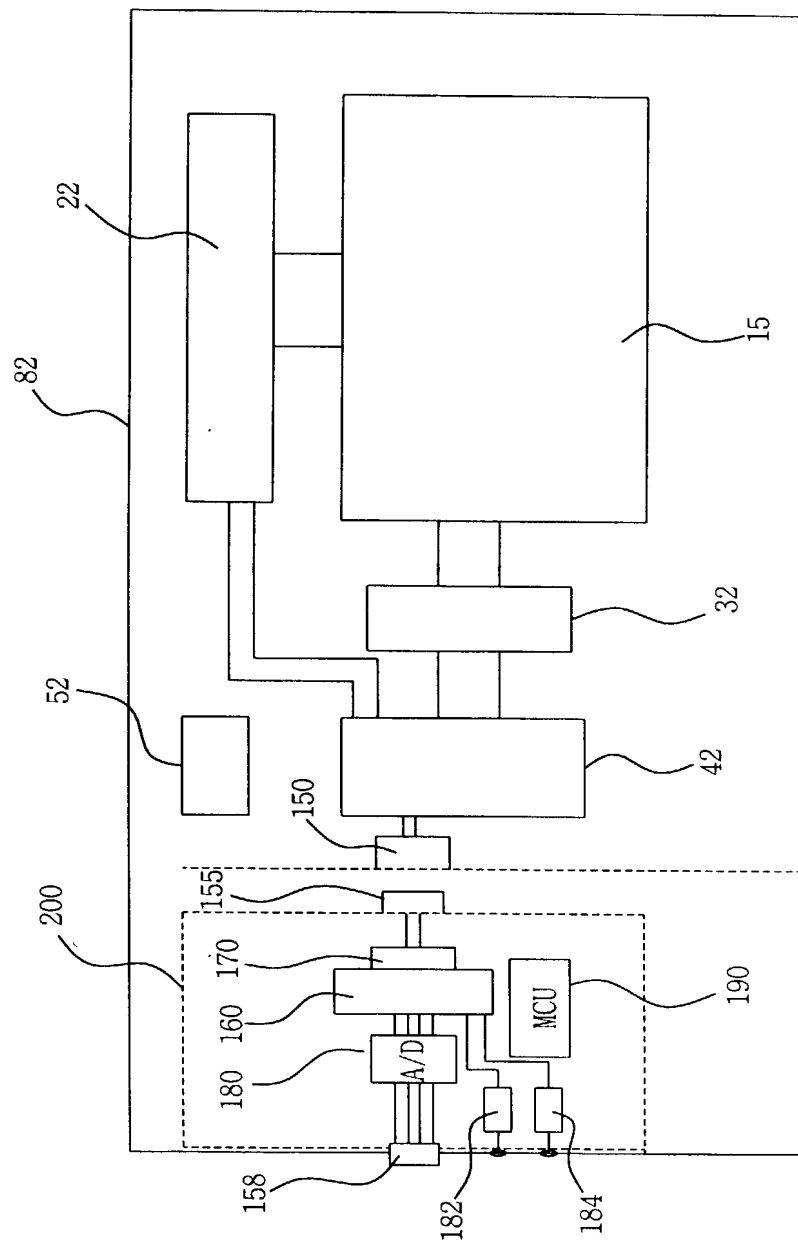


FIG. 3 is a cross-sectional view of the device 100, showing the internal structure of the device 100. The device 100 is a rectangular assembly with a central cavity 110. The device 100 is composed of several layers, including a top layer 10, a middle layer 20, and a bottom layer 30. The device 100 is further divided into sections 25, 35, 40, 70, 80, 90, and 100. The device 100 is shown in a perspective view, with the top layer 10 and the middle layer 20 being the most prominent features. The device 100 is shown in a perspective view, with the top layer 10 and the middle layer 20 being the most prominent features.

FIG. 4



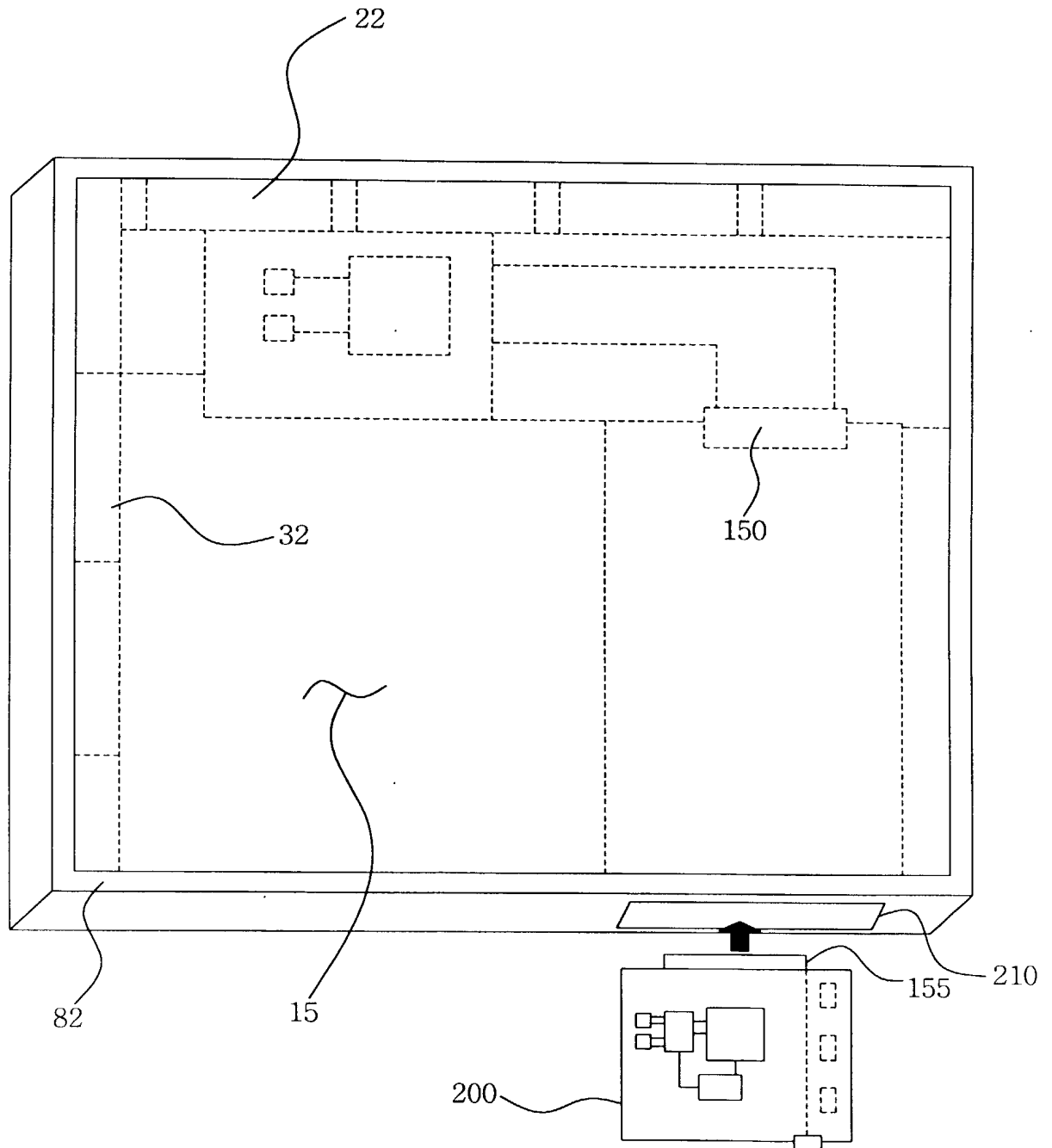


FIG. 6

